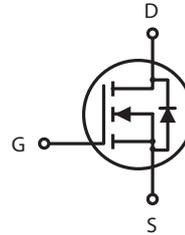


**N-Channel Logic Level Enhancement Mode Field Effect Transistor****PRODUCT SUMMARY**

V <sub>DSS</sub>	I <sub>D</sub>	R <sub>DS(ON)</sub> (mΩ) Max
100V	38A	30 @ V <sub>GS</sub> =10V

**FEATURES**

- Super high dense cell design for low R<sub>DS(ON)</sub>.
- Rugged and reliable.
- TO-263 package.

**ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C unless otherwise noted)**

Symbol	Parameter	Limit	Units
V <sub>DS</sub>	Drain-Source Voltage	100	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Drain Current-Continuous <sup>c</sup>	T <sub>C</sub> =25°C	38
		T <sub>C</sub> =70°C	31.8
I <sub>DM</sub>	-Pulsed <sup>a c</sup>	112	A
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>d</sup>	100	mJ
P <sub>D</sub>	Maximum Power Dissipation	T <sub>C</sub> =25°C	136
		T <sub>C</sub> =70°C	95
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 to 175	°C

**THERMAL CHARACTERISTICS**

R <sub>θ JC</sub>	Thermal Resistance, Junction-to-Case	1.1	°C/W
R <sub>θ JA</sub>	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

**ELECTRICAL CHARACTERISTICS** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>OFF CHARACTERISTICS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=80V, V_{GS}=0V$			1	$\mu A$
$I_{GSS}$	Gate-Body leakage current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	3.0	4.0	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=19A$		24	30	m ohm
$g_{FS}$	Forward Transconductance	$V_{DS}=10V, I_D=19A$		56		S
<b>DYNAMIC CHARACTERISTICS</b> <sup>b</sup>						
$C_{ISS}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V$ $f=1.0\text{MHz}$		1217		pF
$C_{OSS}$	Output Capacitance			147		pF
$C_{RSS}$	Reverse Transfer Capacitance			98		pF
<b>SWITCHING CHARACTERISTICS</b> <sup>b</sup>						
$t_{D(ON)}$	Turn-On DelayTime	$V_{DD}=50V$ $I_D=1A$		31		ns
$t_r$	Rise Time			33		ns
$t_{D(OFF)}$	Turn-Off DelayTime	$V_{GS}=10V$ $R_{GEN}=6\text{ ohm}$		22		ns
$t_f$	Fall Time			36		ns
$Q_g$	Total Gate Charge	$V_{DS}=50V, I_D=19A, V_{GS}=10V$		19		nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=50V, I_D=19A,$ $V_{GS}=10V$		2.9		nC
$Q_{gd}$	Gate-Drain Charge			5.1		nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS</b>						
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_S=6A$		0.78	1.3	V
<b>Notes</b> a. Pulse Test: Pulse Width $\leq 10\mu s$ , Duty Cycle $\leq 1\%$ . b. Guaranteed by design, not subject to production testing. c. Drain current limited by maximum junction temperature. d. Starting $T_J=25^\circ\text{C}, L=0.5\text{mH}, V_{DD}=50V$ . e. Mounted on FR4 Board of $1\text{ inch}^2, 2oz$ .						

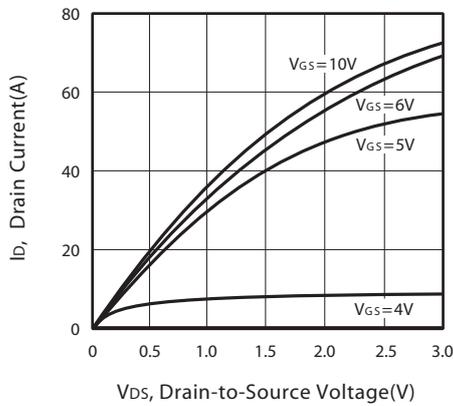


Figure 1. Output Characteristics

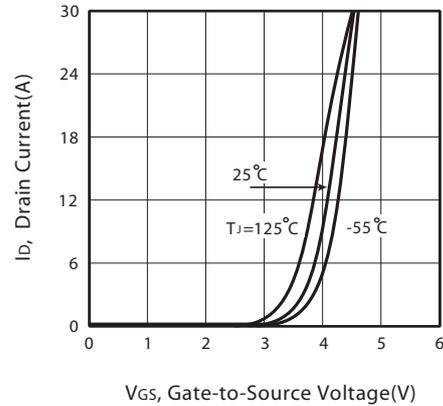


Figure 2. Transfer Characteristics

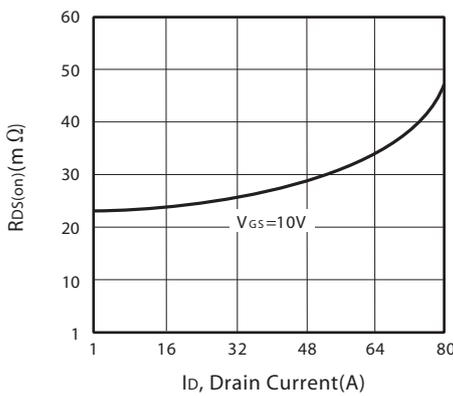


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

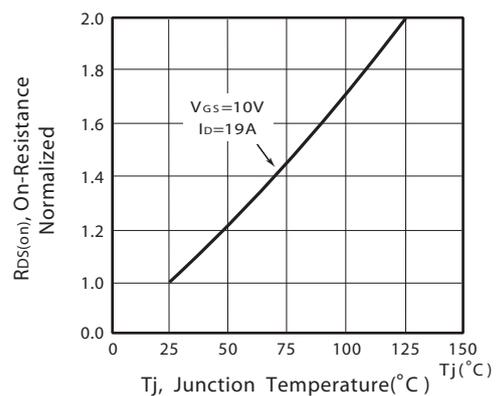


Figure 4. On-Resistance Variation with Drain Current and Temperature

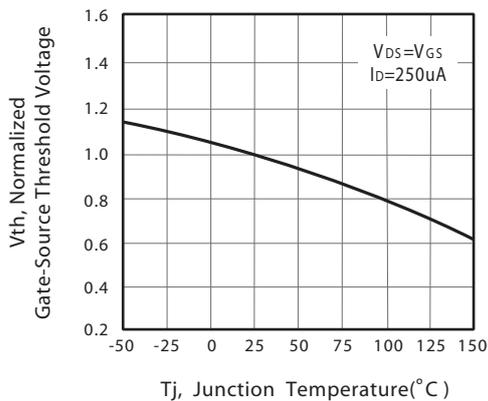


Figure 5. Gate Threshold Variation with Temperature

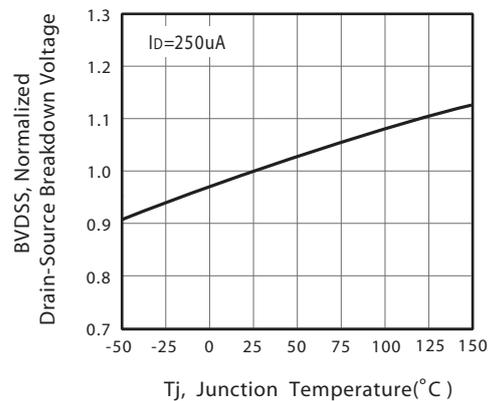


Figure 6. Breakdown Voltage Variation with Temperature

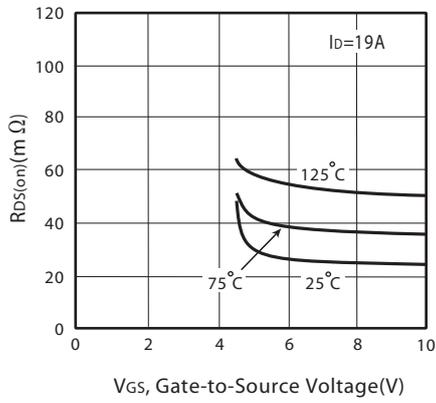


Figure 7. On-Resistance vs. Gate-Source Voltage

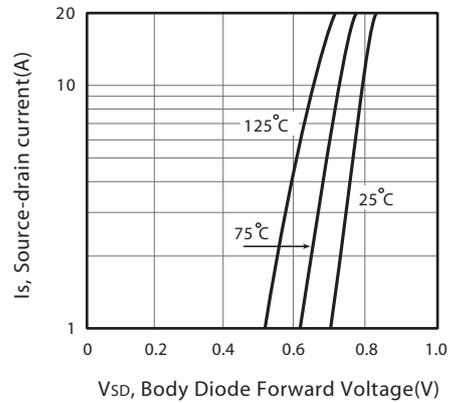


Figure 8. Body Diode Forward Voltage Variation with Source Current

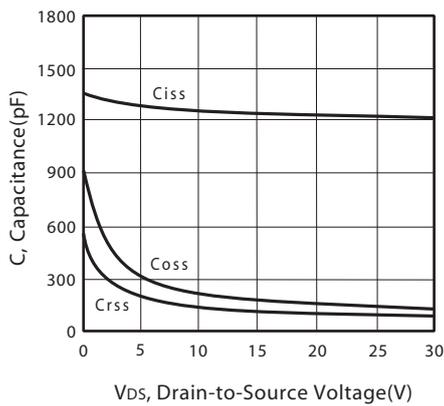


Figure 9. Capacitance

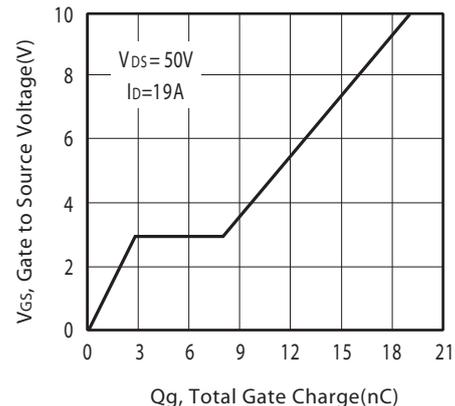


Figure 10. Gate Charge

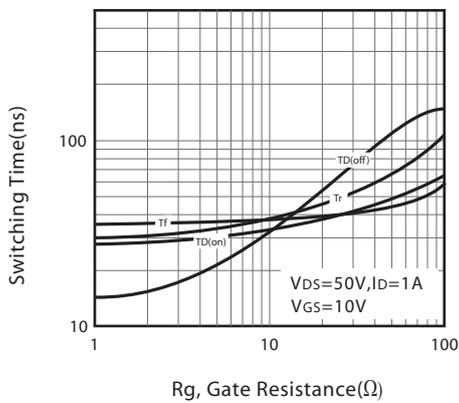


Figure 11. switching characteristics

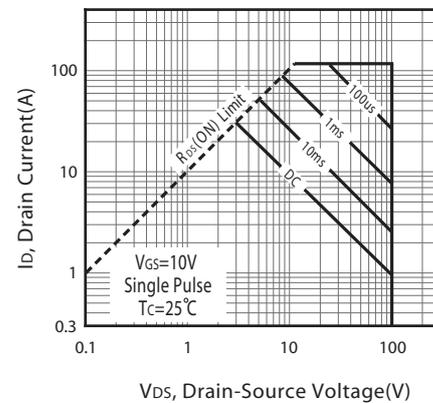
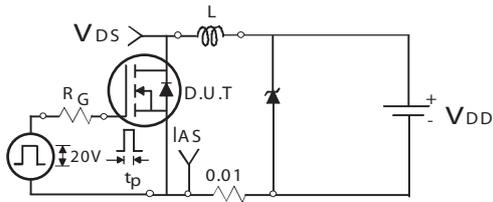
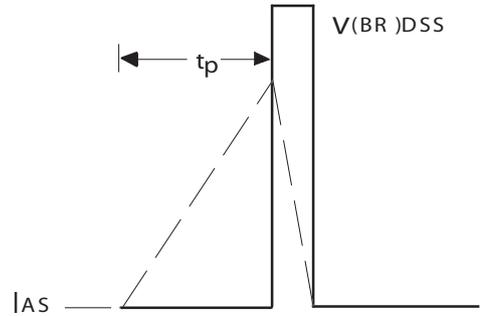


Figure 12. Maximum Safe Operating Area



Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

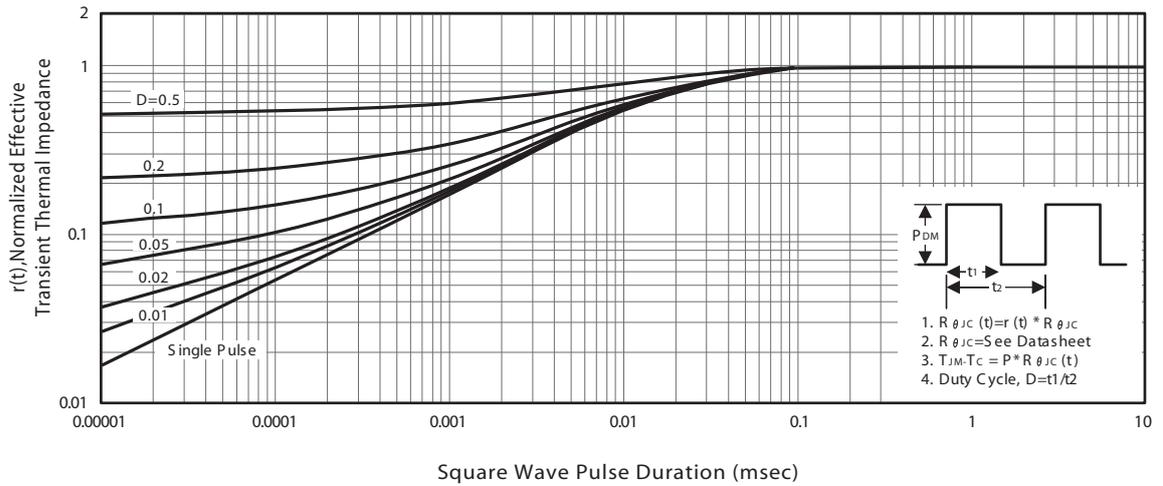
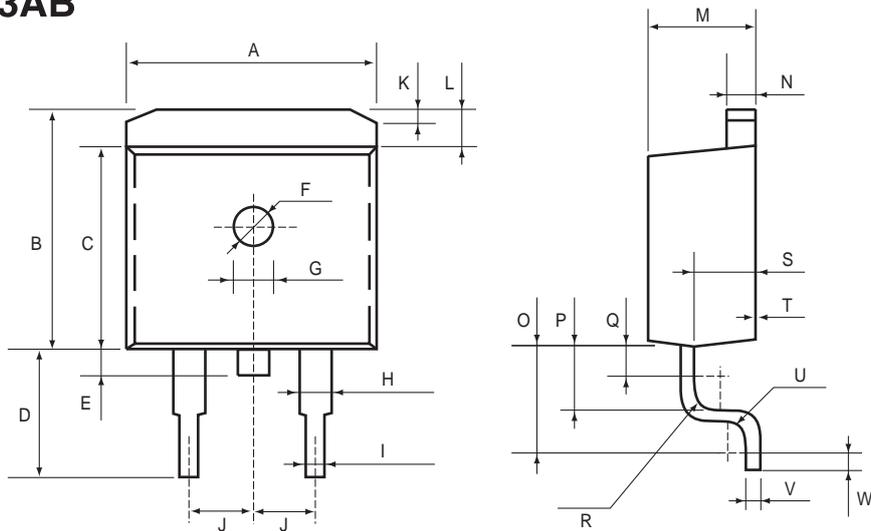


Figure 14. Normalized Thermal Transient Impedance Curve

## PACKAGE OUTLINE DIMENSIONS

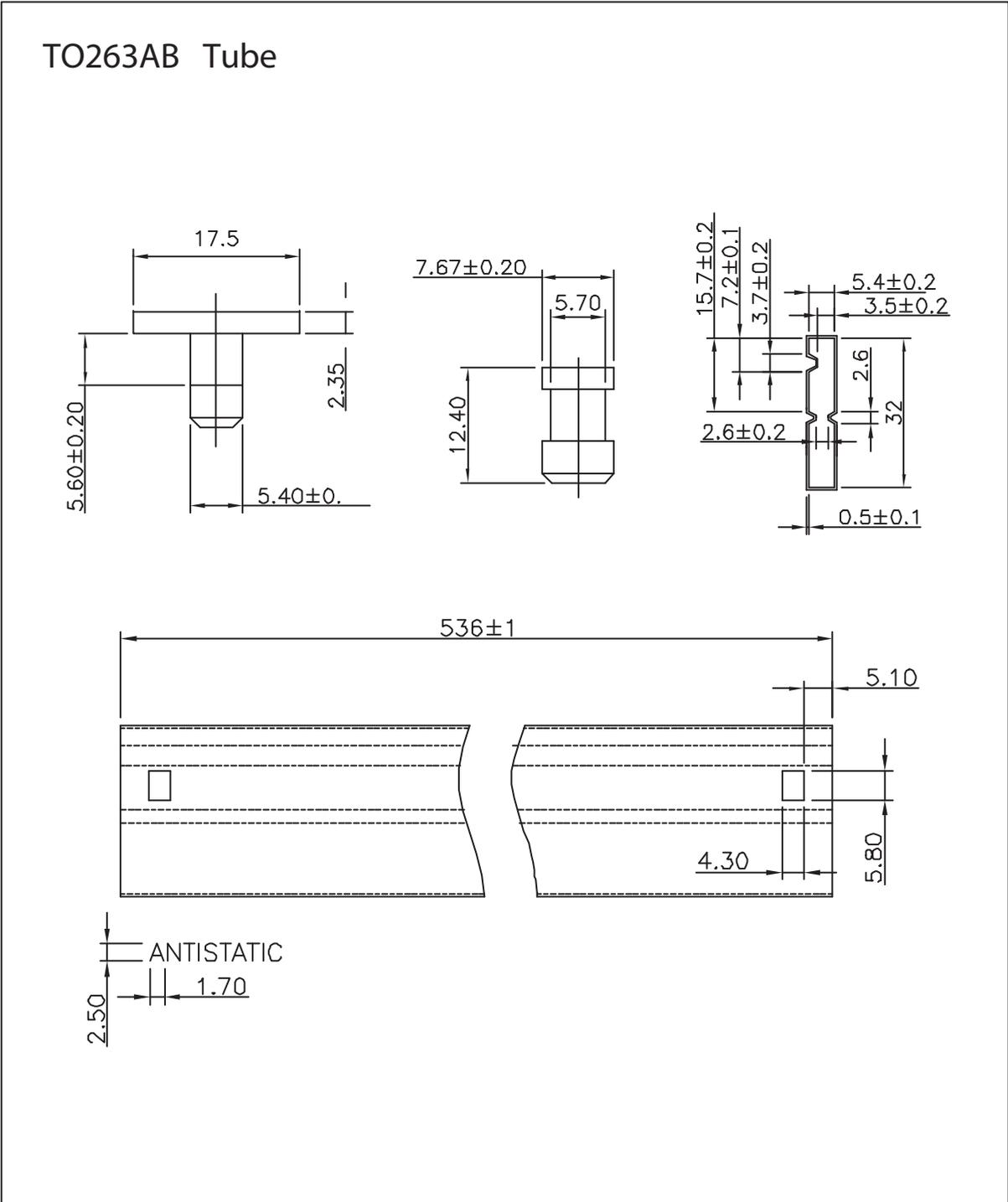
### TO-263AB



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.9	10.5	0.390	0.413
B	9.5	10.3	0.374	0.406
C	8.3	8.9	0.327	0.350
D	4.7	5.5	0.185	0.217
E	1.5		0.059	
F	$\phi$ 1.6		$\phi$ 0.063	
G	1.0	1.4	0.039	0.055
H	1.07	1.47	0.042	0.058
I	0.76	1.06	0.030	0.042
J	2.04	3.04	0.080	0.120
K	0.2	0.6	0.0079	0.024
L	1.4		0.055	
M	4.24	4.64	0.167	0.183
N	1.15	1.45	0.045	0.057
O	3.25	3.75	0.128	0.148
P	2.3		0.091	
Q	1.6		0.063	
R	R0.4	R1.0	R0.0158	R0.0394
S	2.7 MAX		0.106 MAX	
T	0.0	0.3	0.0000	0.0118
U	R0.4	R1.0	R0.0158	R0.0394
V	0.3	0.5	0.0118	0.0197
W	1.2 min		0.047 min	

# STB1082

Ver 1.0



Apr,08,2016

## TOP MARKING DEFINITION

